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Dual N-Channel 60 V (D-S) MOSFET



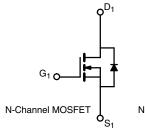
PRODUCT SUMMARY				
V _{DS} (V)	60			
$R_{DS(on)}$ max. (Ω) at V_{GS} = 10 V	0.018			
$R_{DS(on)}$ max. (Ω) at V_{GS} = 4.5 V	0.021			
Q _g typ. (nC)	7.1			
I _D (A)	8 ^a			
Configuration	Dual			

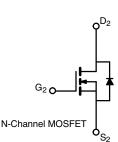
FEATURES

- TrenchFET[®] power MOSFET
- PWM optimized
- 100 % R_a and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

System power DC/DC





ORDERING INFORMATION

Package	PowerPAK SO-8		
Lead (Pb)-free and halogen-free	Si7972DP-T1-GE3		

ABSOLUTE MAXIMUM RATINGS	(T _A = 25 °C, unless o	otherwise noted))		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	60	v	
Gate-source voltage		V _{GS}	± 20	v	
Continuous drain current ($T_J = 150 \ ^\circ C$)	T _C = 25 °C		8 a		
	T _C = 70 °C		8 ^a		
	T _A = 25 °C		8 ^a		
	T _A = 70 °C		8 a	A	
Pulsed drain current		I _{DM}	40		
Source-drain current diode current	T _C = 25 °C	I _S	19		
	T _A = 25 °C		3 ^{b, c}		
Maximum power dissipation	T _C = 25 °C		22		
	T _C = 70 °C		14	w	
	T _A = 25 °C	P _D =	3.6 ^{b, c}	vv	
	T _A = 70 °C		2.3 ^{b, c}		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C	
Soldering recommendations (peak temperature) d, e			260		

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient ^{b, f}	t ≤ 10 s	R _{thJA}	26	35	°C/W	
Maximum junction-to-case (drain)	Steady state	R _{thJC}	4	5.5		

Notes

a. Package limited

b. Surface mounted on 1" x 1" FR4 board

c. t = 10 s

d. See solder profile (www.vishay.com/doc?73257). The PowerPAK SO-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

f. Maximum under steady state conditions is 80 °C/W

S18-0402-Rev. B, 09-Apr-18

Document Number: 75360

RoHS

COMPLIANT

HALOGEN

FREE

Si7972DP

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Si7972DP

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static	1 1					1	
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 V, I_{D} = 250 \mu A$	60	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA	-	38	-	mV/°C	
V _{GS(th)} temperature coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA	-	-4.9	-		
Gate threshold voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	1.2	-	2.7	V	
Gate-body leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$	-	-	100	nA	
Zero gate voltage drain current		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	μA	
	IDSS	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 85 ^{\circ}\text{C}$	-	-	10		
On-state drain current ^b	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	60	-	-	А	
Drain-source on-state resistance ^b	_	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 11 \text{ A}$	-	0.015	0.018	- Ω	
	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$	-	0.017	0.021		
Forward transconductance ^b	9 _{fs}	V _{DS} = 30 V, I _D = 11 A	-	38	-	S	
Dynamic ^a	•						
Input capacitance	C _{iss}		-	1050	-	pF	
Output capacitance	C _{oss}	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	-	435	-		
Reverse transfer capacitance	C _{rss}		-	20	-		
· · · · · · · · · · · · · · · · · · ·		$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 10 \text{ V}, \text{ I}_{D} = 11 \text{ A}$	-	15.2	23	- nC	
Total gate charge	Qg		-	7.1	11		
Gate-source charge	Q _{gs}	$V_{DS} = 30 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 11 \text{ A}$	-	4.4	-		
Gate-drain charge	Q _{gd}		-	1.3	-		
Gate resistance	Rg	f = 1 MHz	0.12	0.6	1.2	Ω	
Turn-on delay time	t _{d(on)}		-	15	120	-	
Rise time	t _r	V_{DD} = 30 V, R_L = 3.45 Ω	-	80	30		
Turn-off delay time	t _{d(off)}	$I_D\widetilde{=}$ 8.7 A, V_{GEN} = 4.5 V, R_g = 1 Ω	-	15	30		
Fall time	t _f		-	15	30	-	
Turn-on delay time	t _{d(on)}		-	10	15	ns	
Rise time	t _r	V_{DD} = 30 V, R_L = 3.45 Ω	-	25	40		
Turn-off delay time	t _{d(off)}	$I_D \cong 8.7$ A, $V_{GEN} = 10$ V, $R_g = 1$ Ω	-	20	30		
Fall time	t _f		-	10	15		
Drain-Source Body Diode Characteristics							
Continuous source-drain diode Current	I _S	T _C = 25 °C	-	-	8	۸	
Pulse diode forward current ^a	I _{SM}		-	-	40	A	
Body diode voltage	V _{SD}	I _S = 8.7 A	-	0.8	1.2	V	
Body diode reverse recovery time	t _{rr}		-	34	51	ns	
Body diode reverse recovery charge	Q _{rr}	I _F = 8.7 A, di/dt = 100 A/µs,	-	30	45	nC	
Reverse recovery fall time	t _a	$T_{\rm J} = 25 \ ^{\circ}{\rm C}$	-	16	-	ns	
Reverse recovery rise time	t _b		-	18	-		

Notes

a. Guaranteed by design, not subject to production testing

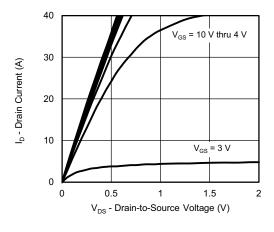
b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

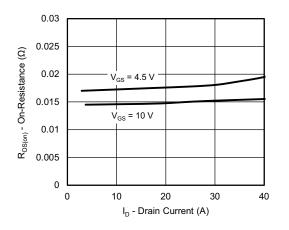
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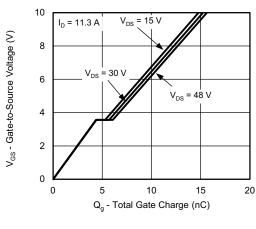
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



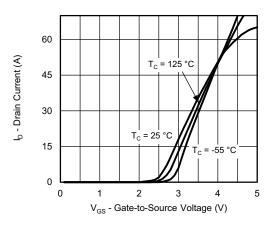
Output Characteristics



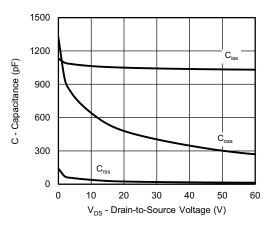
On-Resistance vs. Drain Current



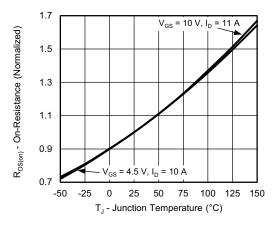
Gate Charge



Transfer Characteristics



Capacitance



On-Resistance vs. Junction Temperature

S18-0402-Rev. B, 09-Apr-18

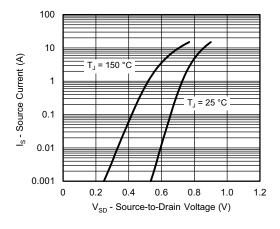
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Document Number: 75360

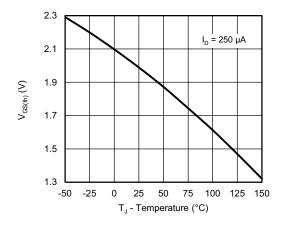
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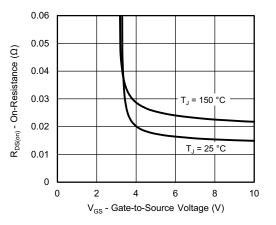
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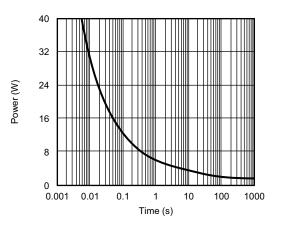
Source-Drain Diode Forward Voltage



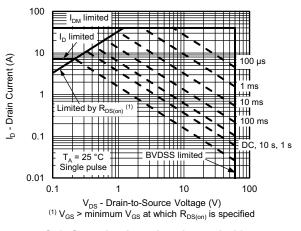
Threshold Voltage



On-Resi.0stance vs. Gate-to-Source Voltage



Single Pulse Power



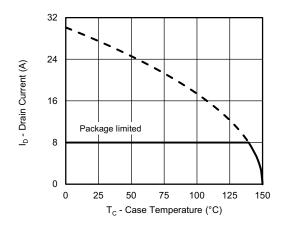
Safe Operating Area, Junction-to-Ambient

4

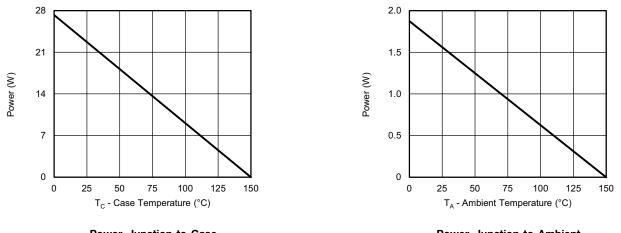
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating a



Power, Junction-to-Case

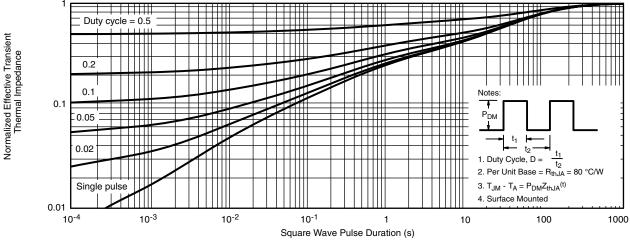
Power, Junction-to-Ambient

Note

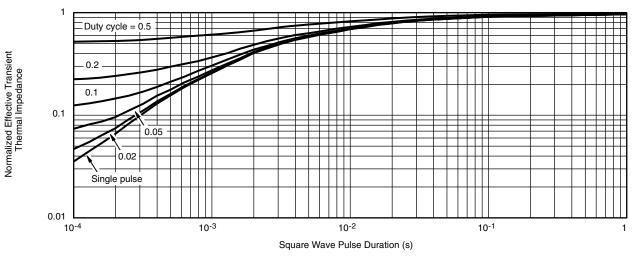
a. The power dissipation P_D is based on T_J max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

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